502685050 02/18/2014

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT2731655

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
YUNG-PEI CHEN	11/26/2013
CHUN-HSIANG FANG	11/17/2013
CHIH-HUNG TSAI	11/05/2013

RECEIVING PARTY DATA

Name:	AU OPTRONICS CORPORATION	
Street Address:	NO. 1, LI-HSIN RD. II, SCIENCE-BASED INDUSTRIAL PARK,	
City:	HSINCHU	
State/Country:	TAIWAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14098455

CORRESPONDENCE DATA

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46355-US-PA
BELINDA LEE
/Belinda Lee/
02/18/2014
This document serves as an Oath/Declaration (37 CFR 1.63).

502685050 REEL: 032240 FRAME: 0102

Total Attachments: 5

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PATENT REEL: 032240 FRAME: 0103

☑ Declaration Submitted With Initial FilingOR
Declaration Submitted After Initial Filing (surcharge 37 CFR 1.16(f) required)
(Title of the Invention)
FLEXIBLE DISPLAY PANEL AND MANUFACTURING METHOD
THEREOF
As a below named inventor (hereinafter designated as the undersigned), I hereby
declare that:
This declaration is directed to:
∑ The attached application,
OR
United States Application Number or PCT International application number
Filed on
The above-identified application was made or authorized to be made by me.
The above-lue filled application was made of authorized to be made by me.
I believe I am the original inventor or an original joint inventor of a claimed invention in
the application.

-1,-

WHEREAS, the undersigned has invented certain new and useful improvements described in the application identified.

WHEREAS 1. Au Optronics Corporation

of No. 1, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring the undersigned's interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by the undersigned, the undersigned has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said the undersigned had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

The undersigned further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

The undersigned hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

Signature: (HEW YUNG-PEL	Date:	November 26, 2013
egal Name of Sole or First Inventor: Yung-Pei Chen		
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4		
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Signature: Chh-Hun	9 Tsai Date: >0(3.11.5
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